Si4682-A10 Single-Chip, FM/HD Radio Receiver



Description

The Si4682 single-chip digital receiver is one member of a family of 100% CMOS digital radio broadcast receiver ICs from Skyworks. The Si468x family offers a complete and cost-effective digital radio solution integrating the RF tuner, baseband and audio processing on a single die. The high level of integration provides significant customer benefits compared to traditional digital radio solutions including a reduction in system implementation complexity, validation and testing, and improved reliability and manufacturability.

The Si4682 is compatible with the iBiquity Digital and NRSC-5 standards for FM In-Band-On-Channel (IBOC) digital radio broadcasting, integrating digital channel demodulation and decoding functions, along with audio decoding and IBOC analog-digital blend. The Si4682 is capable of tuning HD Radio[™] reception to cover additional FM frequencies for future IBOC adoption outside of North America. The Si4682 additionally supports IBOC multicasting, as well as the full-range of HD Radio data services, such as PSD (Program Service Data), Artist Experience, iTunes® Tagging, Bookmark and real-time traffic, with the appropriate external decoders.

The Si4682 additionally supports worldwide FM radio reception and incorporates a fully integrated decoder for the European Radio Data System (RDS) and the North American Radio Broadcast Data System (RDBS) including all required symbol decoding, block synchronization, error detection, and error correction functions.

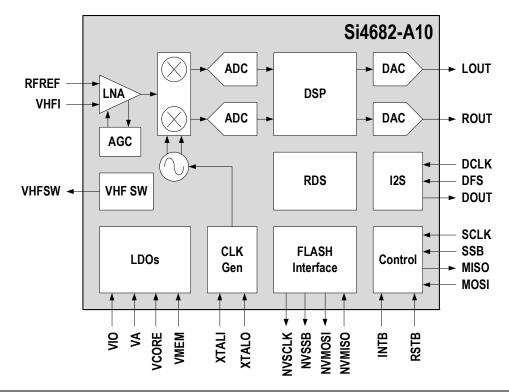
Features

- Worldwide FM band support (76-108 MHz)
- Advanced RDS/RBDS decoder
- FM HD Radio™ support
- Integrated IBOC blend
- Advanced seek functionality
- Advanced audio DSP processing
- I²S digital audio out with ASRC
- Integrated 97 dB stereo audio DAC
- Concurrent I²S/L-R stereo audio out
- Full range of signal quality metrics
- Fully-integrated VCO / PLL / synthesizer
- SPI and I²C host control interfaces
- WLCSP 62-ball. 3.2x3.77x0.59 mm
- QFN 48-pin, 7x7x0.85 mm

Applications

- Mobile phones and tablets
- Clock and tabletop radios
- Stereo boomboxes
- Mini/micro systems
- Docking stations
- Personal navigation devices

For more information, visit the Si468x Digital Radio Receivers web page: www.skyworksinc.com/en/Products/Audio-and-Radio/Si468x-Digital-Radios



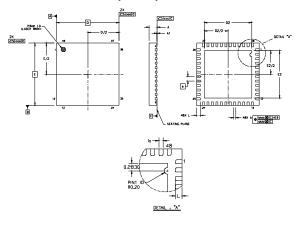
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Selected Electrical Specifications

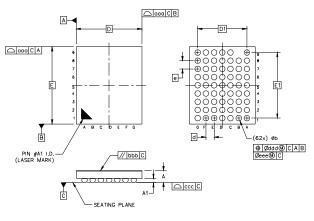
Parameter	Symbol	Test Condition	Min	Тур	Мах	Unit
Ambient Temperature	T _A		-40	25	85	°C
Analog Supply Voltage	V _A		1.71	1.8	2.0	V
Interface Supply Voltage	V _{IO}		1.62	1.8	3.6	V
Core Digital Supply Voltage	V _{CORE}		1.62	1.8	2.0	V
Memory Supply Voltage	V _{MEM}		1.62	1.8	2.0	V
Analog FM			•		•	
Input Frequency	F _{rf}		76	_	108	MHz
Seek Time			_	—	60	ms/ch
FM HD					•	
Input Frequency	F _{rf}		87.5	_	108	MHz
Seek Time			—	—	120	ms/ch

Si4682-A10-GM (QFN)



Dimension Min Nom Max 0.80 0.85 0.90 Α A1 0.00 0.02 0.05 b 0.18 0.25 0.30 D 7.00 BSC D2 5.20 5.30 5.40 0.50 BSC е 7.00 BSC Е 5.20 F2 5.30 5 40 L 0.30 0.40 0.50 0.15 aaa bbb 0.10 ddd 0.05 0.08 eee Notes: All dimensions are shown in millimeters (mm) unless otherwise 1. noted. Dimensioning and tolerancing per ASME Y14.5M-1994. This drawing conforms to JEDEC Outline MO-220, Variation 2. 3. VKKD-4. Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components. 4.

Si4682-A10-GD (WLCSP)



Dimension	Min	Nom	Max		
A	0.55	0.59	0.63		
A1	0.18	0.20	0.22		
b	0.22	0.27	0.32		
D	3.20 BSC.				
E	3.77 BSC.				
d	0.40 BSC.				
е	0.40 BSC.				
D1	2.40 BSC.				
E1	3.20 BSC.				
aaa	0.10				
bbb	0.10				
CCC	0.03				
ddd	0.15				
eee	0.05				

1. All dimensions shown are in millimeters (mm) unless otherwise noted.

Dimensioning and Tolerancing per ANSI Y14.5M-1994.
Primary datum "C" and seating plane are defined by the spherical crowns of the solder balls.

4. Dimension "b" is measured at the maximum solder bump diameter,

parallel to primary datum "C".
Recommended card reflow profile is per the JEDEC/IPC J-STD-020 specification for Small Body Components.